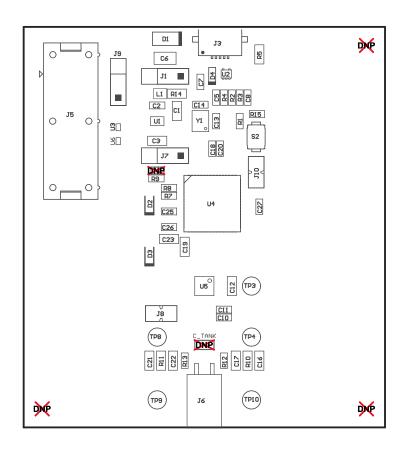
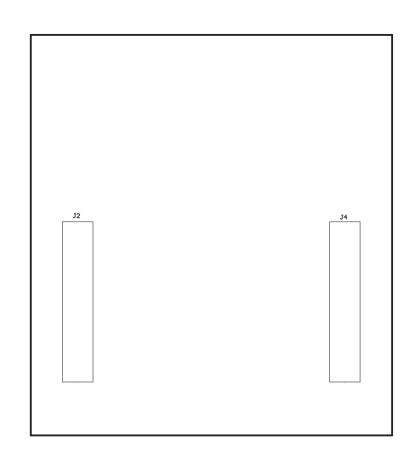
- ZZI Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 

  These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00460	REV: E1	SUN REV:Not In VersionControl		
LAYER NAME = M5 Assembly Top					
PLOT NAME=Top Assembly Drawing	GENERATED	: 6/22/2015	11:28:35 AN TEXAS INSTRUMENTS		



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00460	REV: E1	SVN REV	Not In VersionControl	
	LAYER NAME = M6 Assembly Bottom				
PLOT NAME =Bottom Assembly Drawing	GENERATED	: 6/22/2015	11:28:36 AM	TEXAS INSTRUMENTS	

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